

# INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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First Named Inventor	Yandrasits, Michael A.
Art Unit	1711
Examiner Name	Unknown
Attorney Case Number	59391US002

## U.S. Patent Documents

Exam. Init.*	Cite No.	Document Number	Publication Date or Issue Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Doc. Number-(Kind Code if Known)			
SM	A1	US- 3,635,926	01/18/1972	Gresham et al.	
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D85/30106

\*Examiner:

Date Considered:

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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